

Moret sur Loing, FRANCE has been added as a party to this venture.

No other changes have been made in either the membership or planned activity of the group research project. Membership in this group research project remains open, and ALABC intends to file additional written notification disclosing all changes in membership.

On June 15, 1992, ALABC filed its original notification pursuant to section 6(a) of the Act. The Department of Justice published a notice in the **Federal Register** pursuant to section 6(b) of the Act on July 29, 1992 (57 FR 33522).

The last notification was filed with the Department on December 28, 2000. A notice was published in the **Federal Register** pursuant to section 6(b) of the Act on March 23, 2001 (66 FR 16294).

Constance K. Robinson,

Director of Operations, Antitrust Division.

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DEPARTMENT OF JUSTICE

Antitrust Division

Notice Pursuant to the National Cooperative Research and Production Act of 1993—International SEMATECH, Inc.

Notice is hereby given that, on February 9, 1998, pursuant to section 6(a) of the National Cooperative Research and Production Act of 1993, 15 U.S.C. 4301 *et seq.* ("the Act"), International 300MM Initiative, Inc. (which has changed its name to International SEMATECH, Inc.) has filed written notifications simultaneously with the Attorney General and the Federal Trade Commission disclosing changes in its membership and project status. The notifications were filed for the purpose of extending the Act's provisions limiting the recovery of antitrust plaintiffs to actual damages under specified circumstances. Specifically, Digital Equipment Cooperation, Hudson, MA; Hewlett-Packard Company, Palo Alto, CA; National Semiconductor Cooperation, Santa Clara, CA; Rockwell International, Newport Beach CA; and Siemens Microelectronics, Inc., Cupertino, CA have been added as parties to this venture. Also, International 300MM Initiative, Inc., Austin, TX; LG Semicon Co., Ltd., Cheongju, REPUBLIC OF KOREA; Samsung Electronics Company, Ltd., Seoul, REPUBLIC OF KOREA; and Siemens Components Inc., Cupertino, CA have been dropped as parties to this

venture. As of February 9, 1998, the current list of parties to this venture is as follows: Advanced Micro Devices, Inc., Sunnyvale, CA; Digital Equipment Cooperation, Hudson, MA; Hewlett-Packard Company, Palo Alto, CA; Hyundai Electronics Industries Co., Ltd., Kyongki-do, REPUBLIC OF KOREA; International Business Machines Corporation, Armonk, NY; Intel Corporation, Santa Clara, CA; Lucent Technologies, Inc., Murry Hill, NJ; Motorola, Inc., Schaumburg, IL; National Semiconductor Corporation, Santa Clara, CA; Philips Semiconductors, International BV, Eindhoven, THE NETHERLANDS; Rockwell International, Newport Beach, CA; SGS-THOMSON Microelectronics, Crolles Cedex, FRANCE; Siemens Microelectronics, Inc., Cupertino, CA; Taiwan Semiconductor Manufacturing Company, Ltd., Hsin-Chu, TAIWAN; and Texas Instruments, Inc., Dallas, TX.

The nature and objectives of the venture continues to be to work with its member companies, suppliers, universities and national laboratories to develop equipment, materials, processes, facilities, software and systems for cost-effective advanced semiconductor manufacturing. The scope of the International SEMATECH, Inc. joint venture will be expanded by transferring certain programs in advanced semiconductor manufacturing technology from its parent, SEMATECH, Inc. to International SEMATECH, Inc. In addition to the existing 300MM program, these programs include lithography; environmental safety and health standards; and certain Equipment Productivity Improvements Teams ("EPIT") projects and manufacturing methods.

No other changes have been made in either the membership or planned activity of the group research project. Membership in this group research project remains open, and International SEMATECH, Inc. intends to file additional written notification disclosing all changes in membership.

On August 15, 1996, International 300MM Initiative, Inc. filed its original notification pursuant to section 6(a) of the Act. The Department of Justice published a notice in the **Federal Register** pursuant to section 6(b) of the Act on September 17, 1996 (61 FR 48982).

Constance K. Robinson,

Director of Operations, Antitrust Division.

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DEPARTMENT OF JUSTICE

Antitrust Division

Notice Pursuant to the National Cooperative Research and Production Act of 1993—SEMATECH, Inc. d/b/a International SEMATECH

Notice is hereby given that, on January 19, 2001, pursuant to section 6(a) of the National Cooperative Research and Production Act of 1993, 15 U.S.C. 4301 *et seq.* ("the Act"), SEMATECH, Inc. (which is doing business as International SEMATECH) has filed written notifications simultaneously with the Attorney General and the Federal Trade Commission disclosing changes in its membership and project status. The notifications were filed for the purpose of extending the Act's provisions limiting the recovery of antitrust plaintiffs to actual damages under specified circumstances. Specifically, CONEXANT Systems, Inc., Newport Beach, CA; Hyundai Electronics Industries Company, Ltd., Kyongki-do, REPUBLIC OF KOREA; Infineon Technologies, Munich, GERMANY; Philips Semiconductors International BV, Eindhoven, THE NETHERLANDS; STMicroelectronics, Geneva, SWITZERLAND; and Taiwan Semiconductor Manufacturing Company, Ltd. Hsin-Chu, TAIWAN have been added as parties to this venture. Also, Digital Equipment Corporation, Hudson, MA; National Semiconductor Corporation, Santa Clara, CA; and Rockwell International, Newport Beach, CA have been dropped as parties to this venture. The current list of parties to the venture is as follows: Advanced Micro Devices, Inc., Sunnyvale, CA; CONEXANT Systems, Inc., Newport Beach, CA; Hewlett-Packard Company, Palo Alto, CA; Hyundai Electronics industries Company, Ltd., Kyongki-do, REPUBLIC OF KOREA; Infineon Technologies, Munich, GERMANY; International Business Machines Corporation, Armonk, NY; Intel Corporation, Santa Clara, CA; Lucent Technologies, Inc., Murray Hill, NJ; Motorola, Inc., Schaumburg, IL; Philips Semiconductors International BV, Eindhoven, THE NETHERLANDS; STMicroelectronics, Geneva, SWITZERLAND; Taiwan Semiconductor Manufacturing Company, Ltd., Hsin-Chu, TAIWAN; and Texas Instruments, Inc., Dallas, TX.

The scope of the venture has expanded by conducting programs that were previously performed by its subsidiary, specifically programs in